

<b>FORM PTO-1449</b>  <b>INFORMATION DISCLOSURE CITATION IN AN APPLICATION</b>  <i>(Use several sheets if necessary)</i>	<b>Docket Number (Optional)</b> 81864.0069	<b>Application Number</b> 10/541,096
	<b>Applicant</b> Kyung-ku CHOI, et al.	
	<b>Filing Date</b> June 27, 2005	<b>Group Art Unit</b> 2832

U.S. PATENT DOCUMENTS						
EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE

FOREIGN PATENT DOCUMENTS							
	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Translation	
						YES	NO
	10-308320	11/17/98	JAPAN			Abstract	
	09-035927	02/07/97	JAPAN			Abstract	
	10-241935	09/11/98	JAPAN			Abstract	
	3-77575 (Corresponds to JP Published Application No. 61-178731)	12/11/91	JAPAN				X
	61-178731 (Corresponds to JP 3-77575)	08/11/86	JAPAN			Abstract	

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)	
	Y. Yamaguchi, et al., "Microfabrication and characteristics of magnetic thin-film inductors in the ultrahigh frequency region" J. Appln. Phys., Vol. 85, No. 11, June 1999, pp. 7919-7922
	S. Ohnuma, et al., "High-frequency magnetic properties in metal-nonmetal granular films (invited)" J. Appl. Phys., Vol. 79, No. 8, April 1996, pp. 5130-5135
	Kazuyoshi Kobayashi, et al., "New Ferromagnetic Thin Film Inductor for High-Frequency Applications" J. Ceramic Society of Japan, Vol. 110, No. 5, 2002, pp. 432-435
	Y. Yamada, et al., "Magnetic Properties of CoPt-(C <sub>4</sub> F <sub>8</sub> ) <sub>n</sub> Granular Thin Films" J. Magnetic Society of Japan, Vol. 26, No. 4, 2002, pp. 280-283
	Y. Yamada, et al., "Microstructure and Magnetic Properties of FePt-Fluorocarbon Granular Thin Films" J. Magnetic Society of Japan, Vol. 27, No. 4, 2003, pp. 336-339

<b>EXAMINER</b> /Gary Harris/	<b>DATE CONSIDERED</b> 02/21/2008
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EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP § 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant.